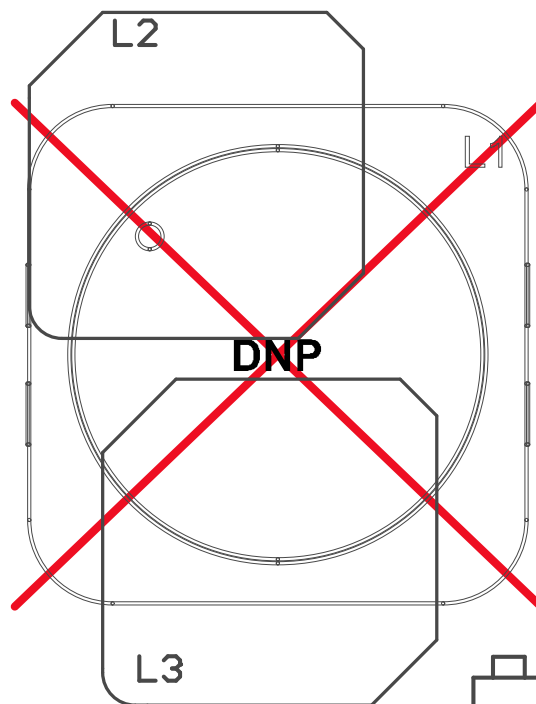
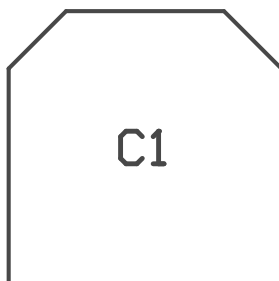
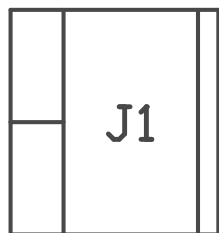


TP1



TP2

R11

TP7



R5

C10

R2

C12

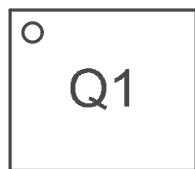
C11

R10

C9



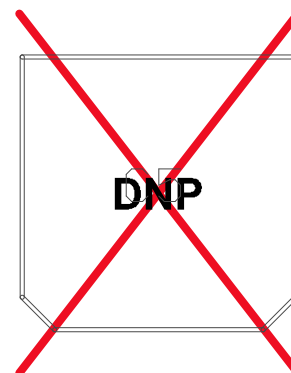
R4



C4

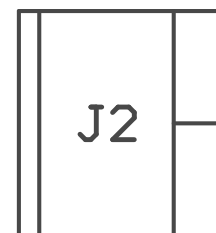
C3

R1



C6

C7



TP5

TP3

TP6

TP4

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